

TLP383

1. Applications

- Programmable Logic Controllers (PLCs)
- AC Adapters
- I/O Interface Boards

2. General

TLP383 is a photocoupler of low input and high isolation type that consists of phototransistor optically coupled to InGaAs infrared emitting diode in a 4-pin SO6L package.

TLP383 is guaranteed high isolation voltage (5000 Vrms) and wide operating temperature range ($T_a = -55$ to 125 °C).

Since TLP383 has a small and thin package compared with a standard DIP package, it is suitable for high-density surface mounting applications such as programmable controllers.

3. Features

- (1) Collector-emitter voltage: 80 V (min)
- (2) Current transfer ratio: 50 % (min)
GB Rank: 100 % (min)
- (3) Isolation voltage: 5000 Vrms (min)
- (4) Operating temperature: -55 to 125 °C
- (5) Safety standard

UL-approved: UL1577 File No.E67349

cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

CQC-approved: GB4943.1, GB8898

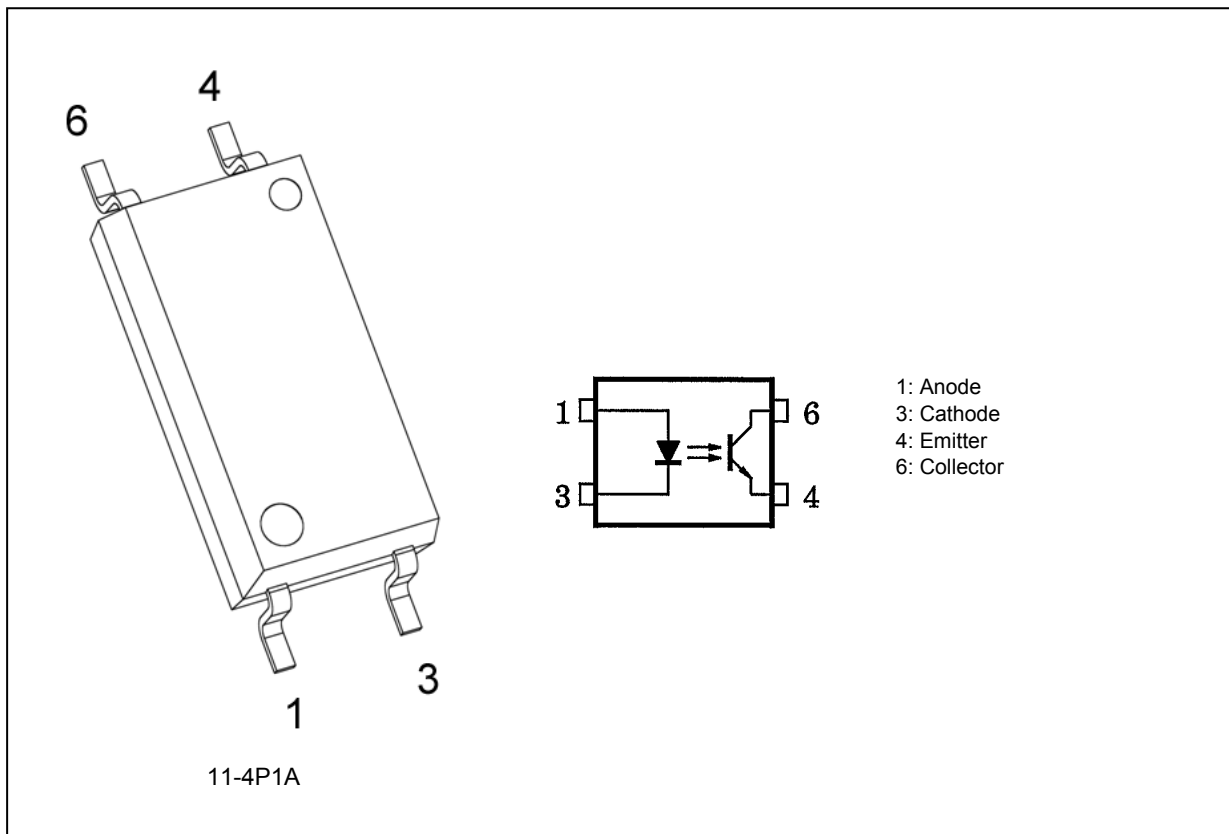
VDE-approved: Option (D4) EN60747-5-5 (**Note**)

Note: When an EN60747-5-5 approved type is needed, please designate the **Option (D4)**.

Start of commercial production

2015-01

4. Packaging and Pin Assignment



5. Mechanical Parameters

Characteristics	Min	Unit
Creepage distances	8.0	mm
Clearance	8.0	
Internal isolation thickness	0.4	

6. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	I_F		50	mA
	Input forward current derating ($T_a \geq 90\text{ }^\circ\text{C}$)	$\Delta I_F/\Delta T_a$		-1.11	mA/ $^\circ\text{C}$
	Input forward current (pulsed)	I_{FP}	(Note 1)	1	A
	Input power dissipation	P_D		100	mW
	Input power dissipation derating ($T_a \geq 90\text{ }^\circ\text{C}$)	$\Delta P_D/\Delta T_a$		-2.22	mW/ $^\circ\text{C}$
	Input reverse voltage	V_R		5	V
Detector	Collector-emitter voltage	V_{CEO}		80	
	Emitter-collector voltage	V_{ECO}		7	
	Collector current	I_C		50	mA
	Collector power dissipation	P_C		150	mW
	Collector power dissipation derating ($T_a \geq 25\text{ }^\circ\text{C}$)	$\Delta P_C/\Delta T_a$		-1.36	mW/ $^\circ\text{C}$
	Junction temperature	T_j		125	$^\circ\text{C}$
Common	Operating temperature	T_{opr}		-55 to 125	
	Storage temperature	T_{stg}		-55 to 125	
	Lead soldering temperature (10 s)	T_{sol}		260	
	Total power dissipation	P_T		250	mW
	Total power dissipation derating ($T_a \geq 25\text{ }^\circ\text{C}$)	$\Delta P_T/\Delta T_a$		-2.5	mW/ $^\circ\text{C}$
	Isolation voltage AC, 60 s, R.H. $\leq 60\%$	BV_S	(Note 2)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width (PW) ≤ 0.1 ms, $f = 100$ Hz

Note 2: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

7. Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

	Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
LED	Input forward voltage	V_F		$I_F = 10$ mA	1.1	1.25	1.4	V
	Input reverse current	I_R		$V_R = 5$ V	—	—	5	μA
	Input capacitance	C_t		$V = 0$ V, $f = 1$ MHz	—	30	—	pF
Detector	Collector-emitter breakdown voltage	$V_{(BR)CEO}$		$I_C = 0.5$ mA	80	—	—	V
	Emitter-collector breakdown voltage	$V_{(BR)ECO}$		$I_E = 0.1$ mA	7	—	—	
	Dark Current	I_{DARK}		$V_{CE} = 48$ V	—	0.01	0.08	μA
				$V_{CE} = 48$ V, $T_a = 85\text{ }^\circ\text{C}$	—	2	50	
	Collector-emitter capacitance	C_{CE}		$V = 0$ V, $f = 1$ MHz	—	10	—	pF

8. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	I_C/I_F	(Note 1)	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	50	—	600	%
			$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}, \text{Rank GB}$	100	—	600	
			$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$	50	—	600	
			$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}, \text{Rank GB}$	100	—	600	
Saturated current transfer ratio	$I_C/I_{F(\text{sat})}$		$I_F = 1\text{ mA}, V_{CE} = 0.4\text{ V}$	—	60	—	
			$I_F = 1\text{ mA}, V_{CE} = 0.4\text{ V}, \text{Rank GB}$	30	—	—	
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		$I_F = 8\text{ mA}, I_C = 2.4\text{ mA}$	—	—	0.3	V
			$I_F = 1\text{ mA}, I_C = 0.2\text{ mA}$	—	0.09	—	
			$I_F = 1\text{ mA}, I_C = 0.2\text{ mA}, \text{Rank GB}$	—	—	0.3	
OFF-state collector current	$I_{C(\text{off})}$		$V_{CE} = 48\text{ V}, V_F = 0.7\text{ V}$	—	—	10	μA

Note 1: See Table 8.1 for current transfer ratio.

Table 8.1 Current Transfer Ratio (CTR) Rank (Note) (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Rank	Test Condition	Current transfer ratio I_C/I_F Min	Current transfer ratio I_C/I_F Max	Marking of classification	Unit
Blank	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	50	600	Blank, YE, GR, GB, Y+, G, G+, BL, B	%
	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$				
Y	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	50	150	YE	
	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$				
GR	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	100	300	GR	
	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$				
GB	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	100	600	GB	
	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$				
BL	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	200	600	BL	
	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$				
YH	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$	75	150	Y+	
GRL	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$	100	200	G	
GRH	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$	150	300	G+	
BLL	$I_F = 0.5\text{ mA}, V_{CE} = 5\text{ V}$	200	400	B	

Note: Specify both the part number and a rank in this format when ordering.

Example: TLP383(GB,E)

For safety standard certification, however, specify the part number alone.

Example: TLP383(GB,E: TLP383)

9. Isolation Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Total capacitance (input to output)	C_S	(Note 1)	$V_S = 0\text{ V}, f = 1\text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	(Note 1)	$V_S = 500\text{ V}, \text{RH} \leq 60\%$	1×10^{12}	10^{14}	—	Ω
Isolation voltage	BV_S	(Note 1)	AC, 60 s	5000	—	—	Vrms
			AC, 1 s in oil	—	10000	—	
			DC, 60 s in oil	—	10000	—	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

10. Switching Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Rise time	t_r		$V_{CC} = 10\text{ V}$, $I_C = 2\text{ mA}$, $R_L = 100\ \Omega$	—	2	—	μs
Fall time	t_f			—	3	—	
Turn-on time	t_{on}			—	3	—	
Turn-off time	t_{off}			—	3	—	
Turn-on time	t_{on}	See Fig. 10.1	$R_L = 1.9\text{ k}\Omega$, $V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$	—	0.95	—	
Storage time	t_s			—	14	—	
Turn-off time	t_{off}			—	28	—	
Turn-on time	t_{on}	See Fig. 10.1	$R_L = 4.7\text{ k}\Omega$, $V_{CC} = 5\text{ V}$, $I_F = 1.6\text{ mA}$	—	7.5	—	
Storage time	t_s			—	7	—	
Turn-off time	t_{off}			—	30	—	

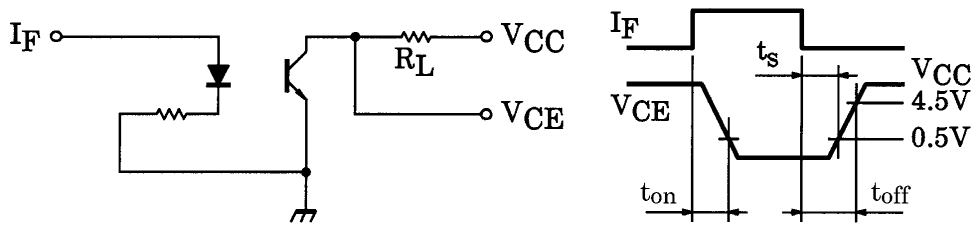


Fig. 10.1 Switching Time Test Circuit

11. Characteristics Curves (Note)

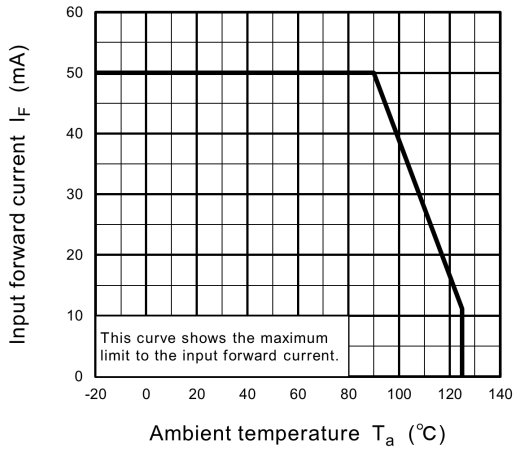


Fig. 11.1 $I_F - T_a$

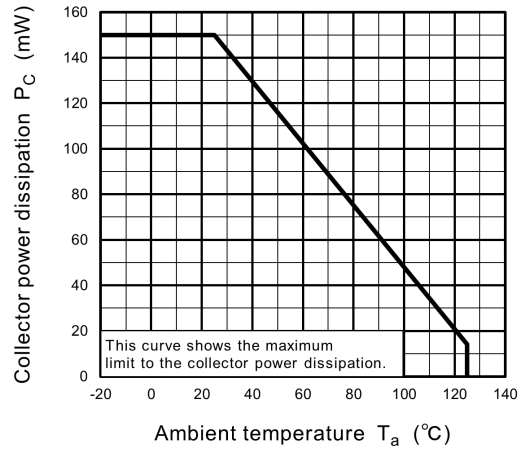


Fig. 11.2 $P_C - T_a$

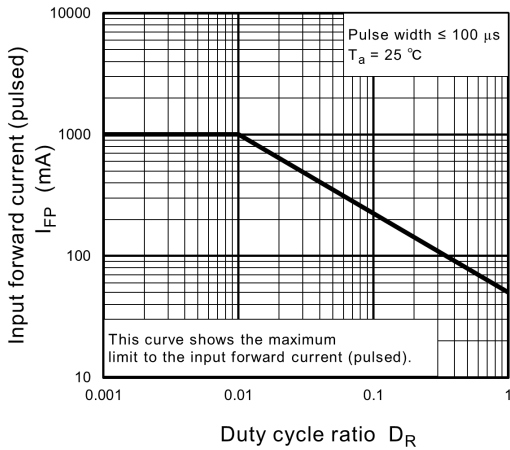


Fig. 11.3 $I_{FP} - D_R$

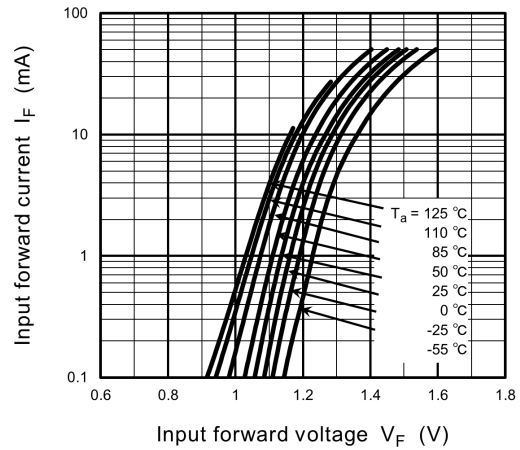


Fig. 11.4 $I_F - V_F$

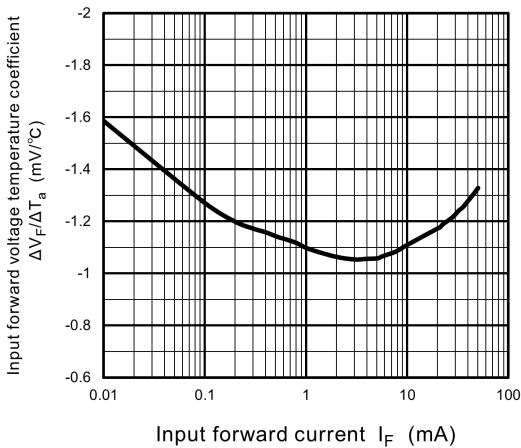


Fig. 11.5 $\Delta V_F/\Delta T_a - I_F$

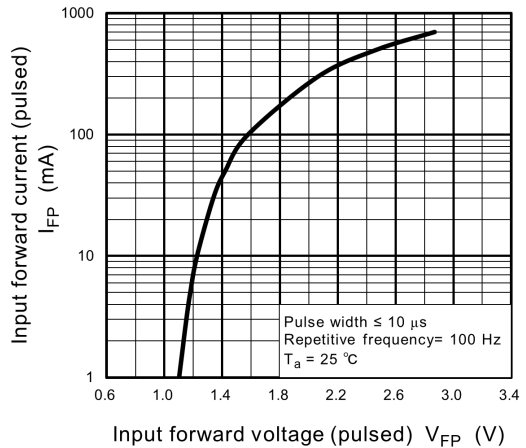


Fig. 11.6 $I_{FP} - V_{FP}$

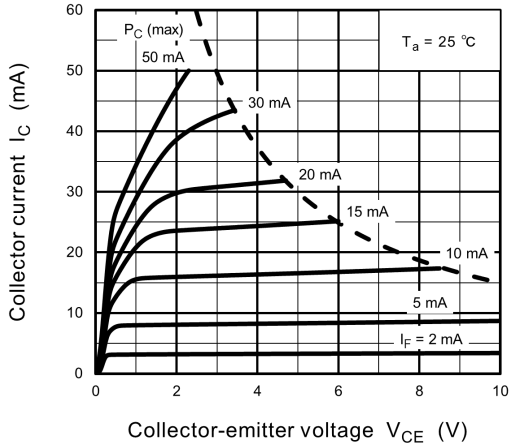


Fig. 11.7 $I_C - V_{CE}$

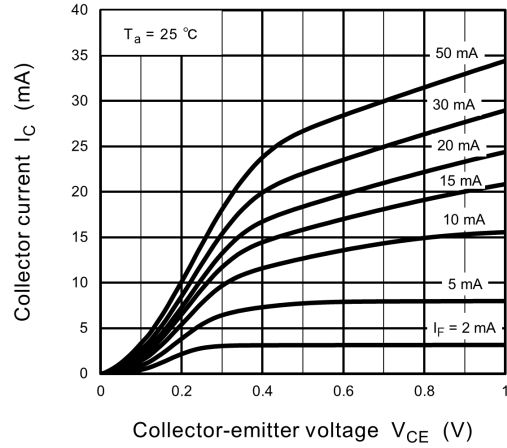


Fig. 11.8 $I_C - V_{CE}$

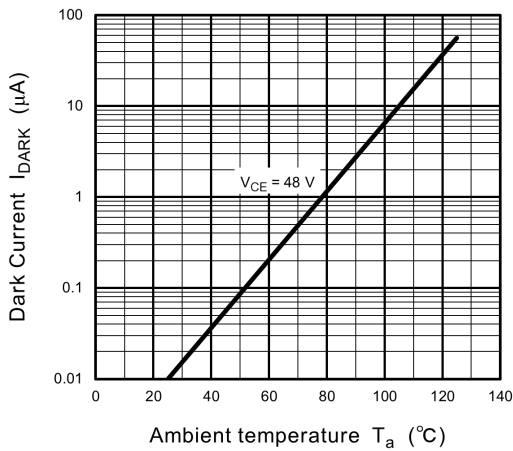


Fig. 11.9 $I_{DARK} - T_a$

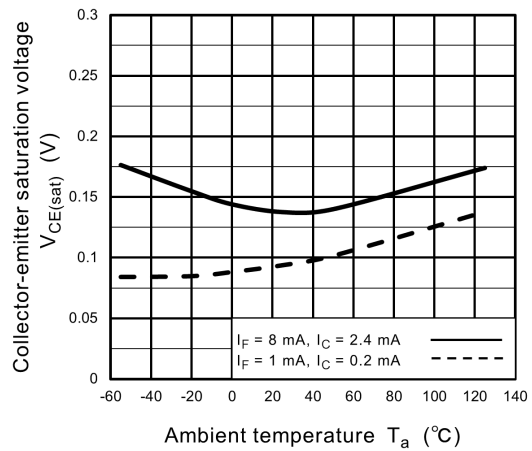


Fig. 11.10 $V_{CE(sat)} - T_a$

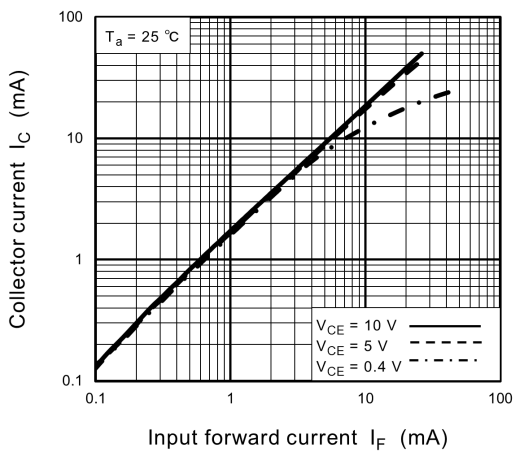


Fig. 11.11 $I_C - I_F$

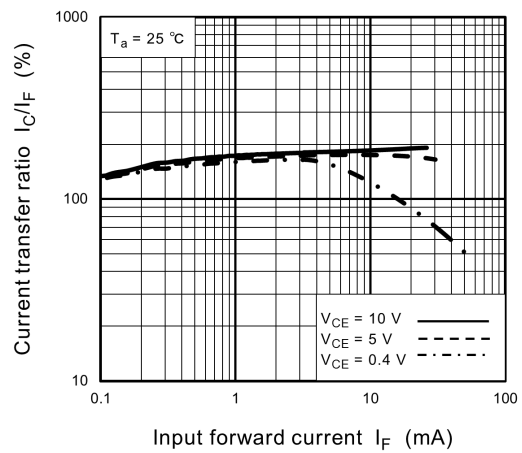


Fig. 11.12 $I_C/I_F - I_F$

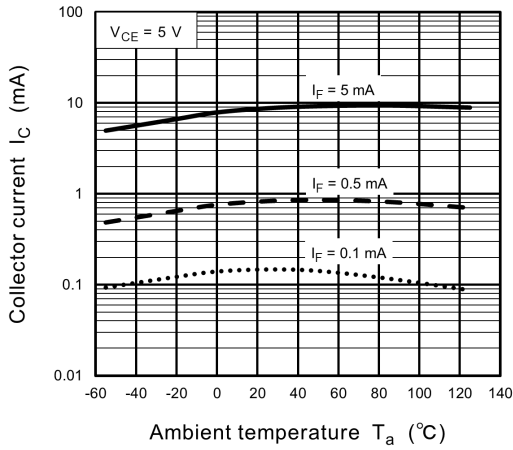


Fig. 11.13 $I_C - T_a$

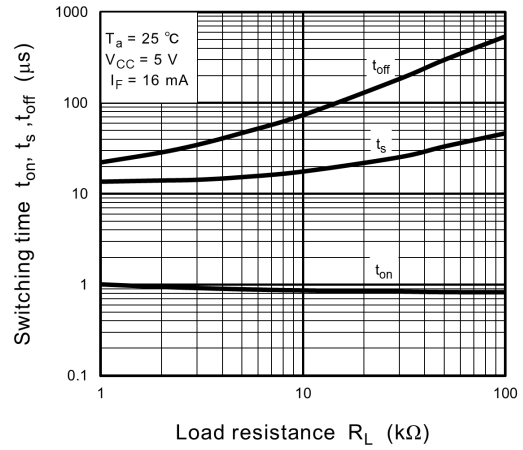


Fig. 11.14 Switching Time - R_L

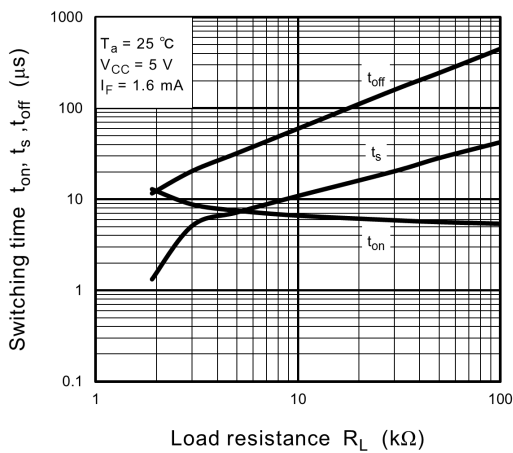


Fig. 11.15 Switching Time - R_L

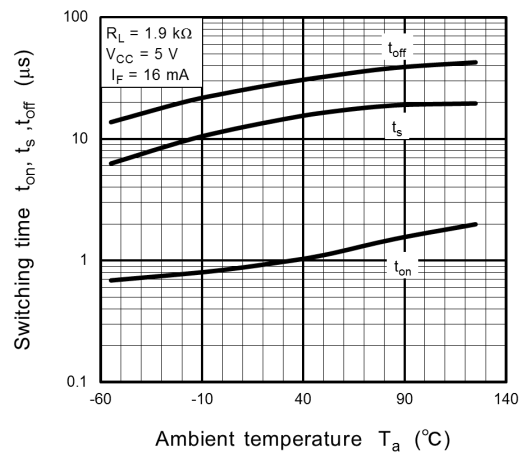


Fig. 11.16 Switching Time - T_a

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

12. Soldering and Storage

12.1. Precautions for Soldering

The soldering temperature should be controlled as closely as possible to the conditions shown below, irrespective of whether a soldering iron or a reflow soldering method is used.

- When using soldering reflow.

The soldering temperature profile is based on the package surface temperature.

(See the figure shown below, which is based on the package surface temperature.)

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.

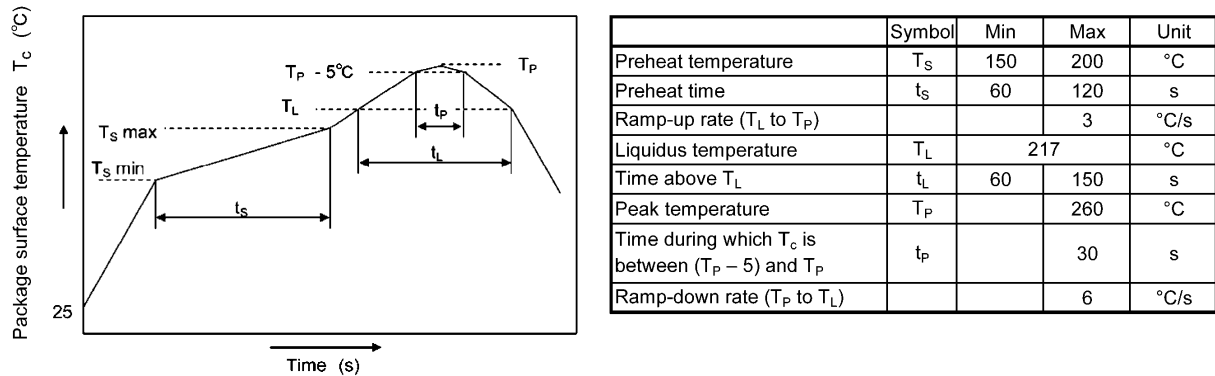


Fig. 12.1.1 An Example of a Temperature Profile When Lead(Pb)-Free Solder Is Used

- When using soldering flow

Apply preheating of 150 °C for 60 to 120 seconds.

Mounting condition of 260 °C within 10 seconds is recommended.

Flow soldering must be performed once.

- When using soldering Iron

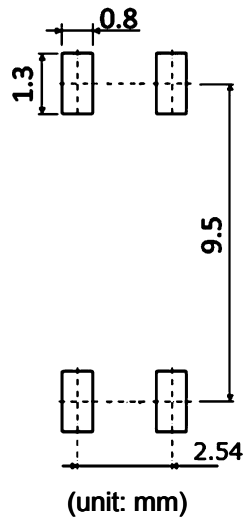
Complete soldering within 10 seconds for lead temperature not exceeding 260 °C or within 3 seconds not exceeding 350 °C

Heating by soldering iron must be done only once per lead.

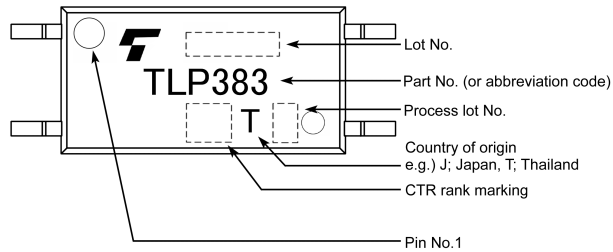
12.2. Precautions for General Storage

- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5 °C to 35 °C and 45 % to 75 %, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

13. Land Pattern Dimensions (for reference only)



14. Marking



15. EN60747-5-5 Option (D4) Specification

- Part number: TLP383 (Note)
- The following part naming conventions are used for the devices that have been qualified according to option (D4) of EN60747.

Example: TLP383(D4GR-TL,E

D4: EN60747 option

GR: CTR rank

TL: Tape type

E: [[G]]/RoHS COMPATIBLE (Note 1)

Note: Use TOSHIBA standard type number for safety standard application.

e.g., TLP383(D4GR-TL,E → TLP383

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

Description	Symbol	Rating	Unit
Application classification for rated mains voltage ≤ 600 Vrms for rated mains voltage ≤ 1000 Vrms		I-IV I-III	—
Climatic classification		55 / 125 / 21	—
Pollution degree		2	—
Maximum operating insulation voltage	V _{IORM}	1230	V _{peak}
Input to output test voltage, Method A V _{pr} = 1.6 × V _{IORM} , type and sample test t _p = 10 s, partial discharge < 5 pC	V _{pr}	1970	V _{peak}
Input to output test voltage, Method B V _{pr} = 1.875 × V _{IORM} , 100 % production test t _p = 1 s, partial discharge < 5 pC	V _{pr}	2310	V _{peak}
Highest permissible overvoltage (transient overvoltage, t _{pr} = 60 s)	V _{TR}	8000	V _{peak}
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve) current (input current I _F , P _{SO} = 0) power (output or total power dissipation) temperature	I _{si} P _{SO} T _s	250 400 150	mA mW °C
Insulation resistance V _{IO} = 500 V, T _a = 25 °C V _{IO} = 500 V, T _a = 100 °C V _{IO} = 500 V, T _a = T _s	R _{si}	≥ 10 ¹² ≥ 10 ¹¹ ≥ 10 ⁹	Ω

Fig. 15.1 EN60747 Insulation Characteristics

Minimum creepage distance	Cr	8.0 mm
Minimum clearance	Cl	8.0 mm
Minimum insulation thickness	ti	0.4 mm
Comparative tracking index	CTI	175

Fig. 15.2 Insulation Related Specifications (Note)

Note: This photocoupler is suitable for **safe electrical isolation** only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.



Fig. 15.3 Marking on packing for EN60747

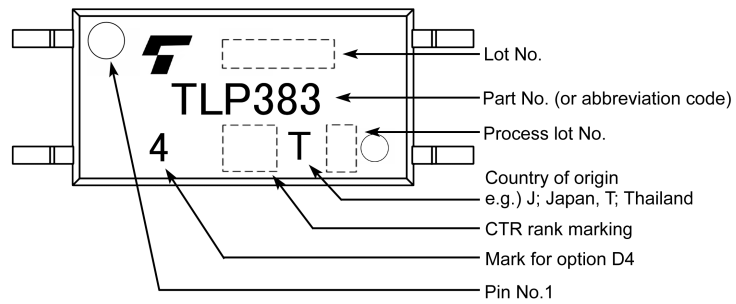


Fig. 15.4 Marking Example (Note)

Note: The above marking is applied to the photocouplers that have been qualified according to option (D4) of EN60747.

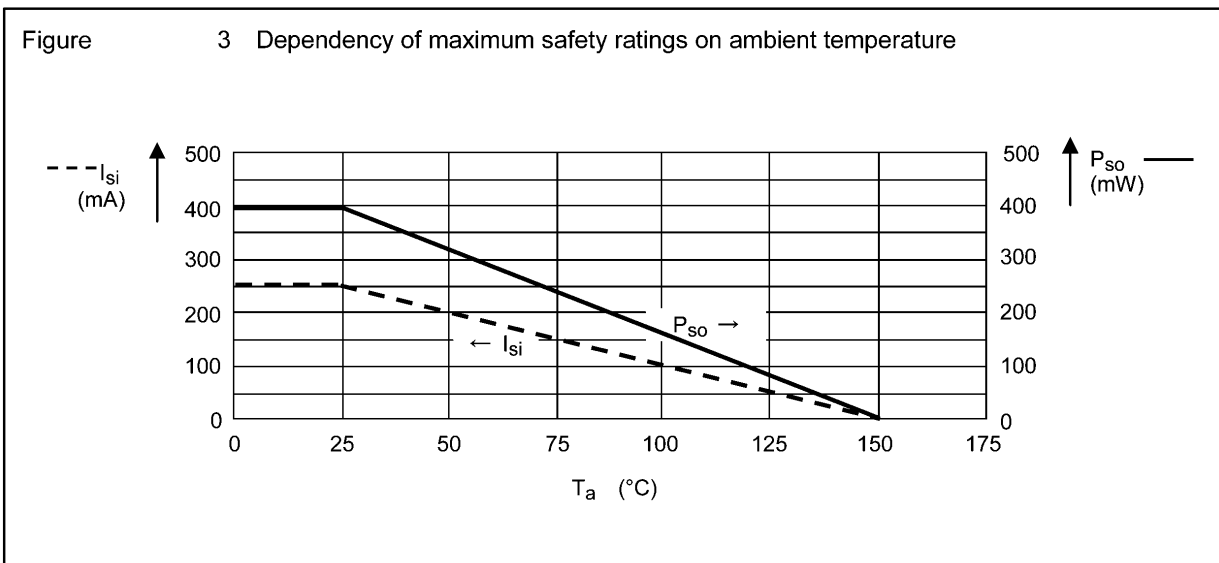
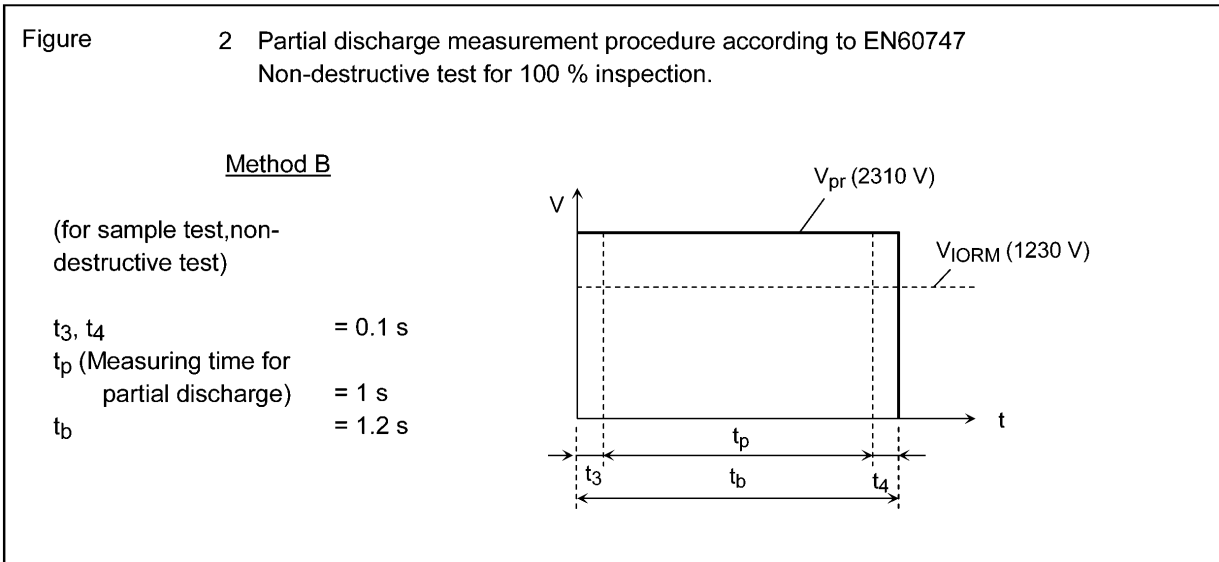
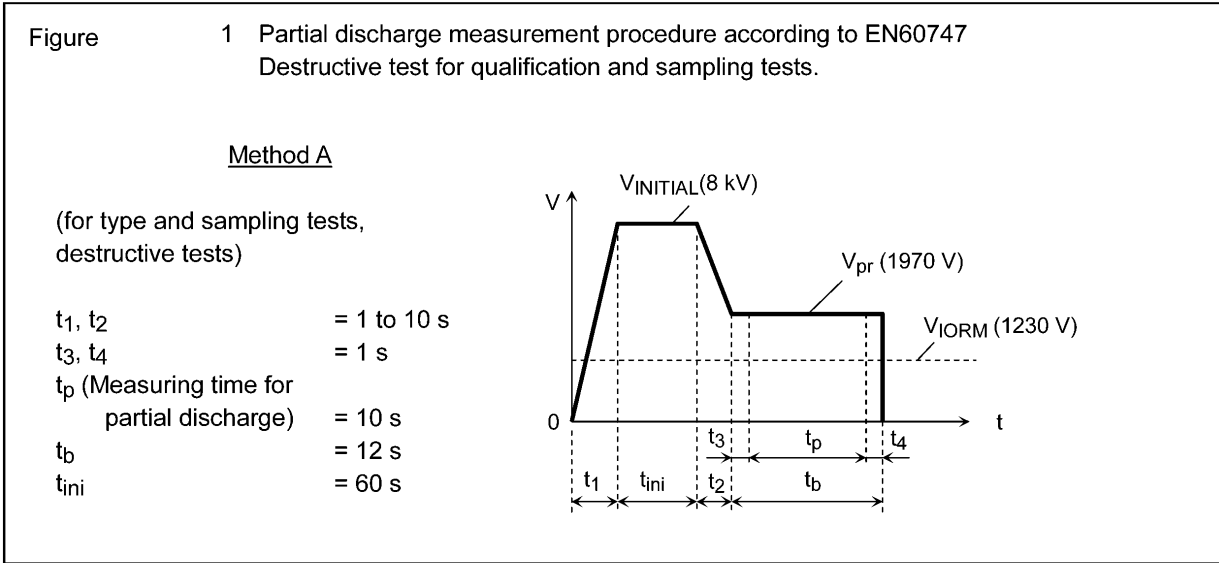


Fig. 15.5 Measurement Procedure

16. Embossed-Tape Packing (TPL),(TPR) Specification for Mini-Flat Photocouplers

16.1. Applicable Package

Package Name	Product Type
SO6L	Long creepage mini flat coupler

16.2. Product Naming Conventions

Type of package used for shipment is denoted by a symbol suffix after a part number. The method of classification is as below.

Example) TLP383(GR-TPL,E

Part number: TLP383

CTR rank: GR

Tape type: TPL

[[G]]/RoHS COMPATIBLE: E (**Note**)

Note: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

16.3. Tape Dimensions Specification

TPL:L direction, TPR:R direction

16.3.1. Orientation of Device in Relation to Direction of Feed

Device orientation in the carrier cavities as shown in Fig. 16.3.1.1

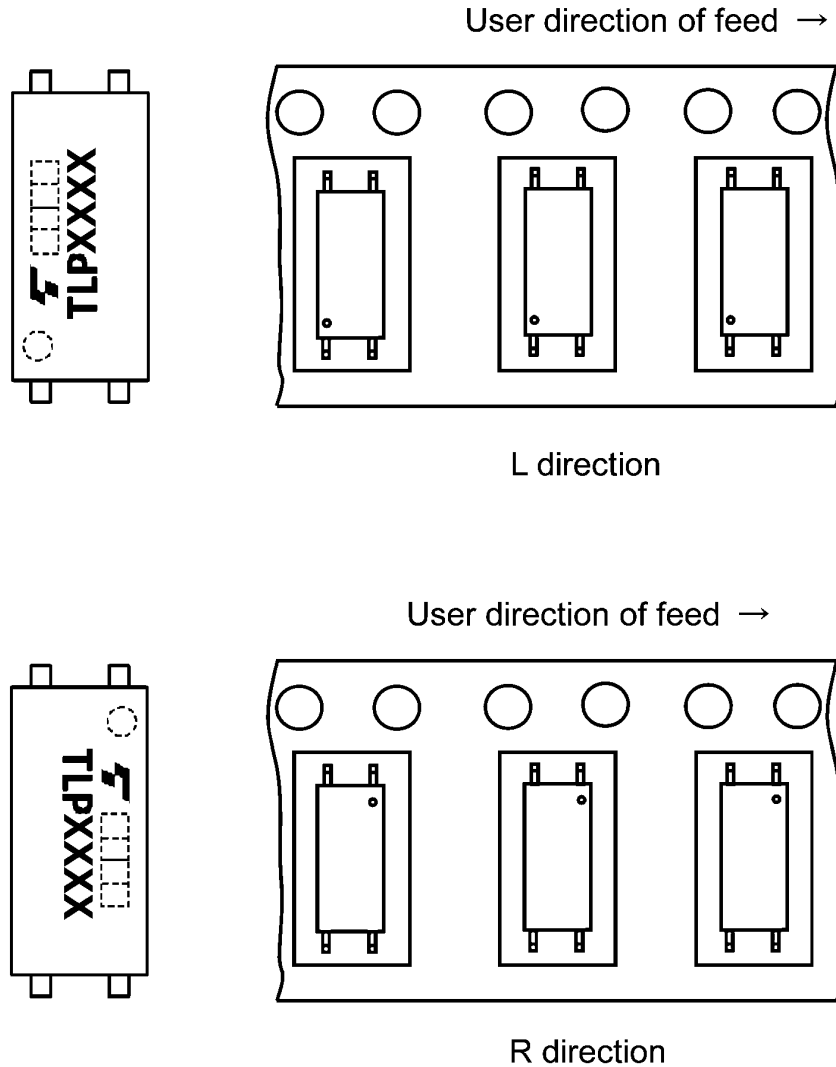


Fig. 16.3.1.1 Device Orientation

16.3.2. Packing Quantity

3000 pcs per reel

16.3.3. Empty Cavities

Table 16.3.3.1 Empty Cavities

Characteristics	Criterion	Remarks
Occurrences of 2 or more successive empty cavities	0	Within any given 40-mm section of tape, not including leader and trailer
Single empty cavity	6 devices (max) per reel	Not including leader and trailer

16.3.4. Tape Leader and Trailer

The start end of the tape has 50 or more empty cavities. The hub end of the tape has 50 or more empty cavities and two empty turns only for a cover tape.

16.3.5. Tape Dimensions

Tape material: Plastic (for protection against static electricity)

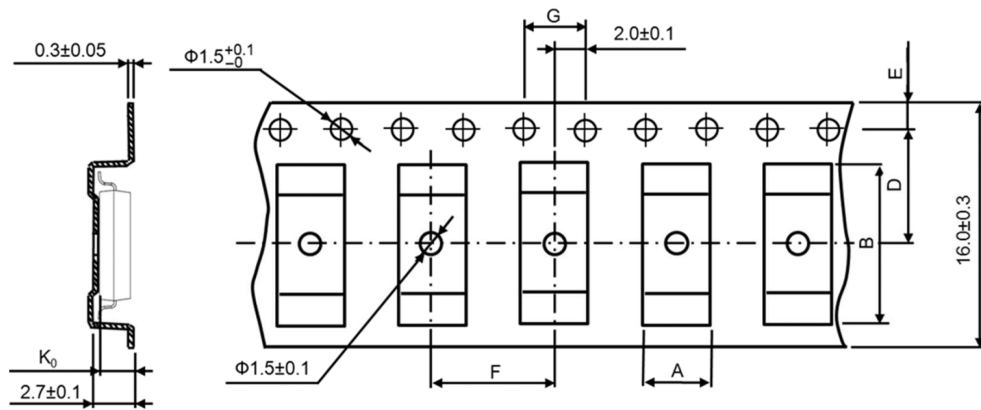


Fig. 16.3.5.1 Tape Dimensions

Table 16.3.5.1 Tape Dimensions (unit: mm, unless otherwise specified: ±0.1)

Symbol	Dimension	Remark
A	4.24	—
B	10.4	—
D	7.5	Center line of embossed cavity and sprocket hole
E	1.75	Distance between tape edge and sprocket hole center
F	8.0	—
G	4.0	Cumulative error ±0.2 (max) per 10 sprocket holes
K ₀	2.4	Internal space

16.3.6. Reel Specification

Material: Plastic

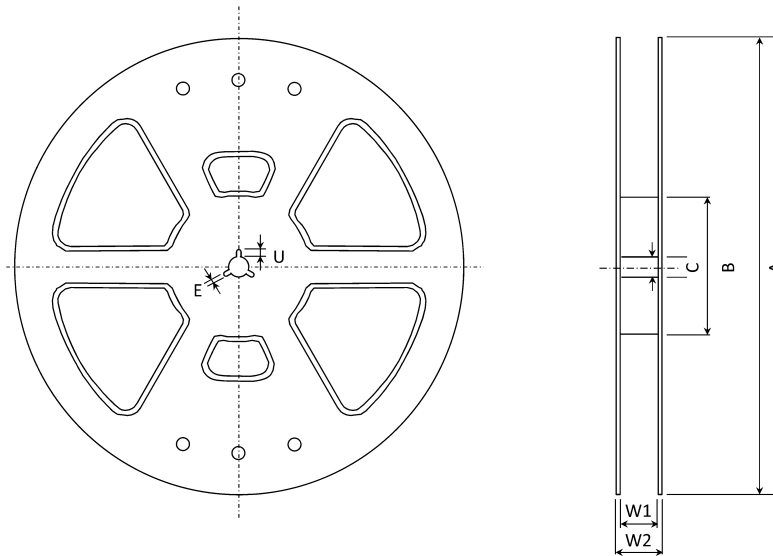


Fig. 16.3.6.1 Reel Dimensions

Table 16.3.6.1 Reel Dimensions (unit: mm)

Symbol	Dimension
A	$\phi 330 \pm 2$
B	$\phi 100 \pm 1$
C	$\phi 13 \pm 0.5$
E	2.0 ± 0.5
U	4.0 ± 0.5
W1	17.5 ± 0.5
W2	21.4 ± 1.0

16.4. Packing

Either one reel or ten reels (maximum) of photocouplers are packed in a shipping carton.

16.5. Label Format

The label on each carton provides the part number, quantity, lot number, the Toshiba logo, CTR rank, etc.

16.6. Ordering Information

When placing an order, please specify the part number, CTR rank, tape type and quantity as shown in the following example.

Example) TLP383(GR-TPL,E 3000 pcs

Part number: TLP383

CTR rank: GR

Tape type: TPL(L direction)

[[G]]/RoHS COMPATIBLE: E (Note)

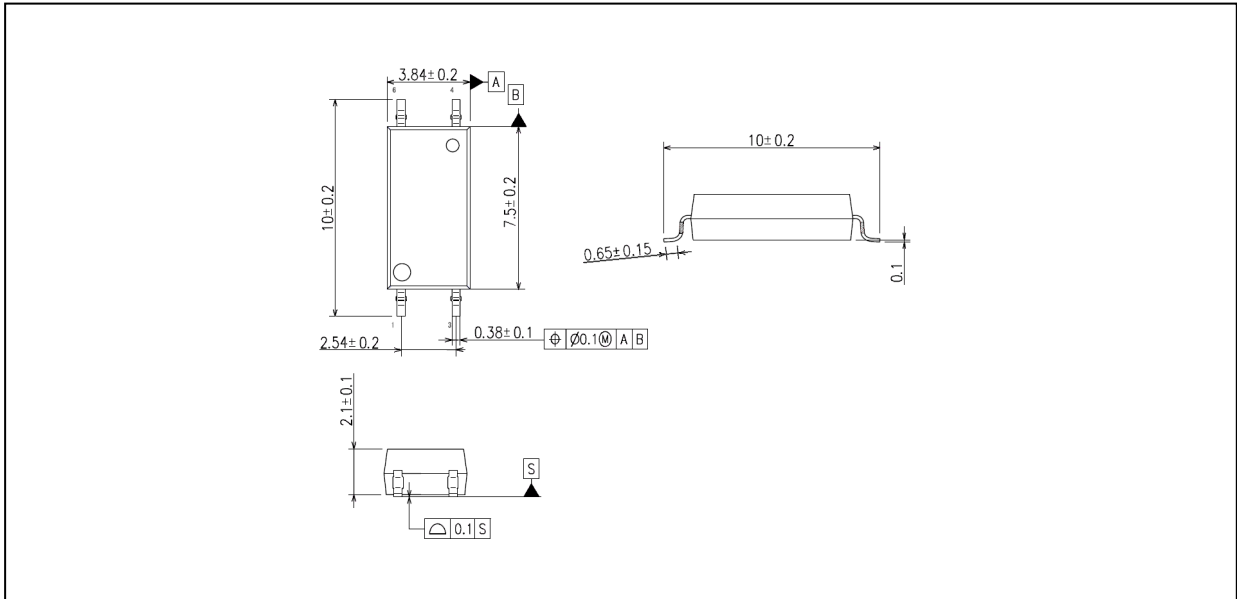
Quantity (must be a multiple of 3000 pcs): 3000 pcs

Note: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

Package Dimensions

Unit: mm



Weight: 0.128 g (typ.)

Package Name(s)
TOSHIBA: 11-4P1A

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